SLOS223D - MAY 1999 - REVISED MAY 2001

Compatible With PC 99 Desktop Line-Out Into 10- $k\Omega$ Load

- Compatible With PC 99 Portable Into 8-Ω Load
- Internal Gain Control, Which Eliminates External Gain-Setting Resistors
- DC Volume Control From 20 dB to −40 dB
- 2-W/Ch Output Power Into 3-Ω Load
- PC-Beep Input
- Depop Circuitry
- Stereo Input MUX
- Fully Differential Input
- Low Supply Current and Shutdown Current
- Surface-Mount Power Packaging 24-Pin TSSOP PowerPAD™

(TOP VIEW) 24 GND □ ☐ GND PCB ENABLE □ 2 23 □□ RLINEIN VOLUME □ 3 22 TT SHUTDOWN 4 21 LOUT+ □ ☐ ROUT+ LLINEIN I 5 20 ☐ RHPIN \square V_{DD} LHPIN 6 19 18 7 PV_{DD} PV_{DD} □ 8 17 RIN 🞞 ☐ CLK LOUT-9 16 ☐ ROUT− SE/BTL LIN \square 15 10 □ PC-BEEP BYPASS □ 11 14 GND □ 12 13 ☐ GND

PWP PACKAGE

description

The TPA0132 is a stereo audio power amplifier in a 24-pin TSSOP thermally enhanced package capable of delivering 2 W of continuous RMS power per channel into 3- Ω loads. This device minimizes the number of external components needed, which simplifies the design and frees up board space for other features. When driving 1 W into 8- Ω speakers, the TPA0132 has less than 0.4% THD+N across its specified frequency range.

Included within this device is integrated depop circuitry that virtually eliminates transients that cause noise in the speakers.

Amplifier gain is controlled by means of a dc voltage input on the VOLUME terminal. There are 31 discrete steps covering the range of 20 dB (maximum volume setting) to –40 dB (minimum volume setting) in 2-dB steps. When the VOLUME terminal exceeds 3.54 V, the device is muted. An internal input MUX allows two sets of stereo inputs to the amplifier. In notebook applications, where internal speakers are driven as BTL and the line outputs (often headphone drive) are required to be SE, the TPA0132 automatically switches into SE mode when the SE/BTL input is activated, and this effectively reduces the gain by 6 dB.

The TPA0132 consumes only 10 mA of supply current during normal operation. A shutdown mode is included that reduces the supply current to less than 150 μ A.

The PowerPAD package (PWP) delivers a level of thermal performance that was previously achievable only in TO-220-type packages. Thermal impedances of approximately 35° C/W are readily realized in multilayer PCB applications. This allows the TPA0132 to operate at full power into $8-\Omega$ loads at ambient temperatures of 85° C.

AVAILABLE OPTIONS

	PACKAGED DEVICE		
^T A	TSSOP† (PWP)		
	(FVVF)		
-40°C to 85°C	TPA0132PWP		

[†] The PWP package is available taped and reeled. To order a taped and reeled part, add the suffix R to the part number (e.g., TPA0132PWPR).



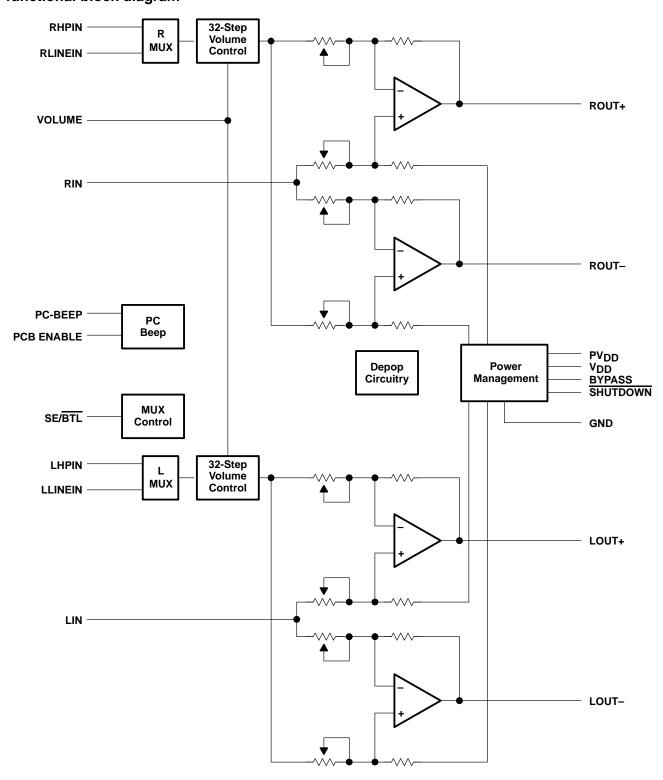
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerPAD is a trademark of Texas Instruments.



SLOS223D - MAY 1999 - REVISED MAY 2001

functional block diagram





Terminal Functions

TERMINAL						
NAME	NO.	I/O	DESCRIPTION			
BYPASS	11		Tap to voltage divider for internal mid-supply bias generator			
CLK	17	I	If a 47-nF capacitor is attached, the TPA0132 generates an internal clock. An external clock can override the internal clock input to this terminal.			
GND	1, 12 13, 24		Ground connection for circuitry. Connected to thermal pad			
LHPIN	6	1	Left channel headphone input, selected when SE/BTL is held high			
LIN	10	I	Common left input for fully differential input. AC ground for single-ended inputs.			
LLINEIN	5	I	Left channel line negative input, selected when SE/BTL is held low			
LOUT+	4	0	Left channel positive output in BTL mode and positive output in SE mode			
LOUT-	9	0	Left channel negative output in BTL mode and high-impedance in SE mode			
PCB ENABLE	2	I	If this terminal is high, the detection circuitry for PC-BEEP is overridden and passes PC-BEEP through the amplifier, regardless of its amplitude. If PCB ENABLE is floating or low, the amplifier continues to operate normally.			
PC-BEEP	14	I	The input for PC-Beep mode. PC-BEEP is enabled when a > 1-V (peak-to-peak) square wave is input to PC-BEEP or PCB ENABLE is high.			
PV_{DD}	7, 18	I	Power supply for output stage			
RHPIN	20	I	Right channel headphone input, selected when SE/BTL is held high			
RIN	8	I	Common right input for fully differential input. AC ground for single-ended inputs.			
RLINEIN	23	I	Right channel line input, selected when SE/BTL is held low			
ROUT+	21	0	Right channel positive output in BTL mode and positive output in SE mode			
ROUT-	16	0	Right channel negative output in BTL mode and high-impedance in SE mode			
SE/BTL			Input and output MUX control. When this terminal is held high, the LHPIN or RHPIN and SE output is selected. When this terminal is held low, the LLINEIN or RLINEIN and BTL output are selected.			
SHUTDOWN	22	I	When held low, this terminal places the entire device, except PC-BEEP detect circuitry, in shutdown mode.			
V_{DD}	19	I	Analog V _{DD} input supply. This terminal needs to be isolated from PV _{DD} to achieve highest performance.			
VOLUME	3	ı	VOLUME detects the dc level at the terminal and sets the gain for 31 discrete steps covering a range of 20 dB to -40 dB for dc levels of 0.15 V to 3.54 V. When the dc level is over 3.54 V, the device is muted.			



TPA0132 2-W STEREO AUDIO POWER AMPLIFIER WITH DC VOLUME CONTROL

SLOS223D - MAY 1999 - REVISED MAY 2001

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \leq 25^{\circ} \mbox{C}$	DERATING FACTOR	T _A = 70°C	T _A = 85°C
PWP	2.7 W [‡]	21.8 mW/°C	1.7 W	1.4 W

^{\$\}frac{1}{2}\$ See the Texas Instruments document, PowerPAD Thermally Enhanced Package Application Report(literature number SLMA002), for more information on the PowerPAD™ package. The thermal data was measured on a PCB layout based on the information in the section entitled Texas Instruments Recommended Board for PowerPAD™ on page 33 of the before mentioned document.

recommended operating conditions

		M	IIN	MAX	UNIT	
Supply voltage, V _{DD}		4	4.5	5.5	V	
High level input voltage V	SE/BTL		4			
High-level input voltage, V _{IH}	SHUTDOWN		2		v	
Low-level input voltage, V _{IL}	SE/BTL			3	V	
	SHUTDOWN			0.8	V	
Operating free-air temperature, T _A		-	40	85	°C	

electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN TYP MAX	UNIT
IVool	Output offset voltage (measured differentially)	$V_{I} = 0 V$, $A_{V} = 2 V/V$	25	mV
PSRR	Power supply rejection ratio	V _{DD} = 4 V to 5 V	67	dB
IIIII	High-level input current	$V_{DD} = 5.5 \text{ V}, \qquad V_{I} = V_{DD}$	900	nA
I _{IL}	Low-level input current	$V_{DD} = 5.5 \text{ V}, \qquad V_{I} = 0 \text{ V}$	900	nA
Z _I	Input impedance		See Figure 28	
1	Supply current	BTL mode	10 15	A
^I DD		SE mode	5 7.5	mA
I _{DD(SD)}	Supply current, shutdown mode		150 300	μΑ



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

TPA0132 2-W STEREO AUDIO POWER AMPLIFIER WITH DC VOLUME CONTROL SLOS223D - MAY 1999 - REVISED MAY 2001

operating characteristics, V_{DD} = 5 V, T_A = 25°C, R_L = 4 Ω , Gain = 2 V/V, BTL mode (unless otherwise noted)

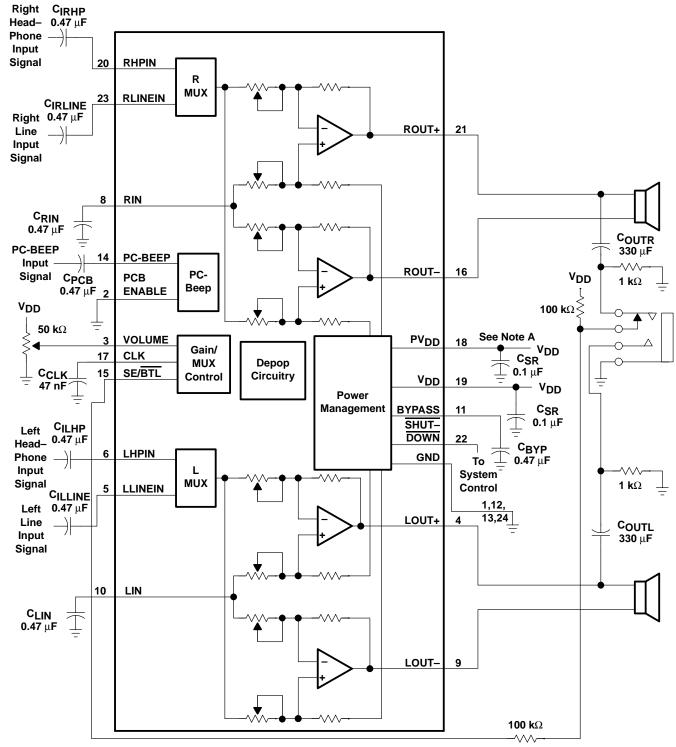
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
PO	Output power	THD = 1%,	f = 1 kHz		2		W
THD+N	Total harmonic distortion plus noise	P _O = 1 W,	f = 20 Hz to 15 kHz		0.4%		
ВОМ	Maximum output power bandwidth	THD = 5%			>15		kHz
	Supply ripple rejection ratio	Supply simple rejection ratio	BTL mode		65		dB
		$C_{(BYP)} = 0.47 \mu F$	SE mode		60		uБ
Vn	Noise output voltage	$C_{(BYP)} = 0.47 \mu F,$ f = 20 Hz to 20 kHz	BTL mode		34		μVRMS
			SE mode		44		

TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
	Total harmonic distortion plus noise	vs Output power	1, 4, 6, 8, 10
THD+N		vs Voltage gain	2
I I II D+IN		vs Frequency	3, 5, 7, 9, 11
		vs Output voltage	12
٧n	Output noise voltage	vs Frequency	13
	Supply ripple rejection ratio	vs Frequency	14, 15
	Crosstalk	vs Frequency	16, 17, 18
	Shutdown attenuation	vs Frequency	19
SNR	Signal-to-noise ratio	vs Frequency	20
	Closed loop response		21, 22
PO	Output power	vs Load resistance	23, 24
D-	Power dissipation	vs Output power	25, 26
PD		vs Ambient temperature	27
Z _i	Input impedance	vs Gain	28

APPLICATION INFORMATION

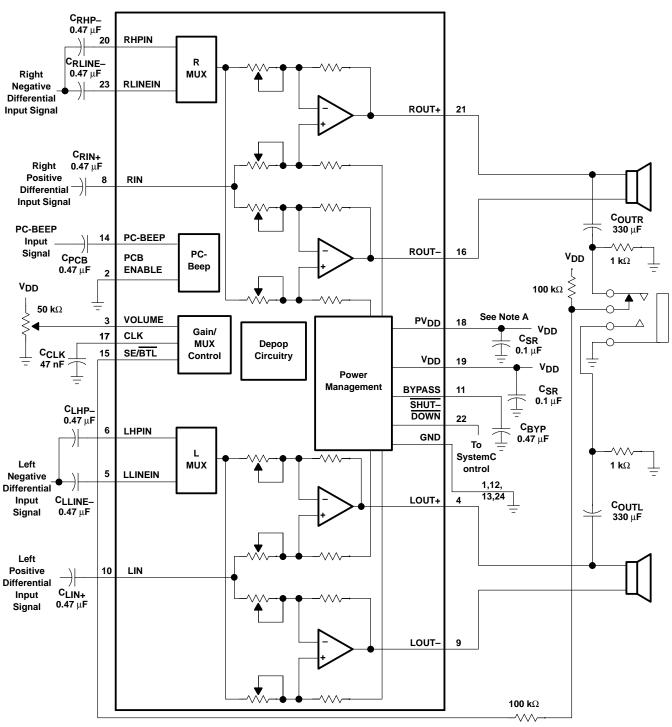


NOTE A: A 0.1- μ F ceramic capacitor should be placed as close as possible to the IC. For filtering lower-frequency noise signals, a larger electrolytic capacitor of 10 μ F or greater should be placed near the audio power amplifier.

Figure 29. Typical TPA0132 Application Circuit Using Single-Ended Inputs and Input MUX



APPLICATION INFORMATION



NOTE A: A 0.1-μF ceramic capacitor should be placed as close as possible to the IC. For filtering lower-frequency noise signals, a larger electrolytic capacitor of 10 μF or greater should be placed near the audio power amplifier.

Figure 30. Typical TPA0132 Application Circuit Using Differential Inputs

